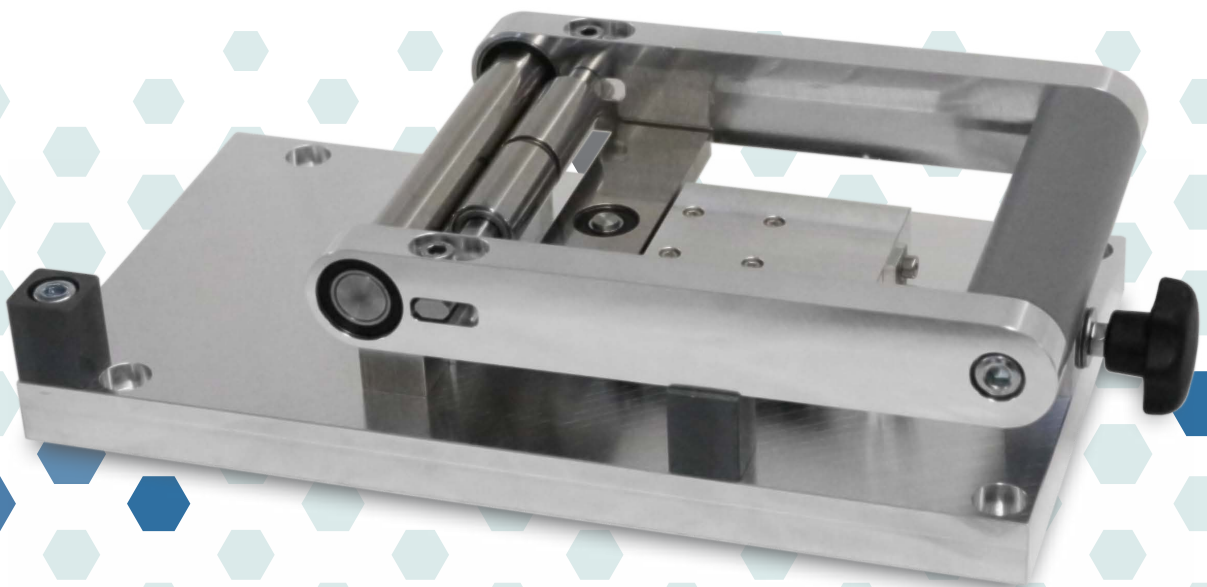
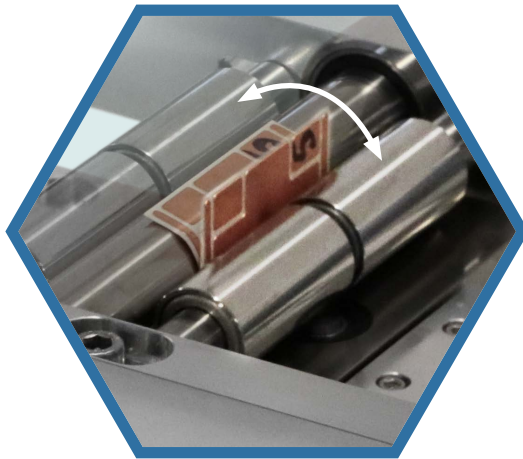


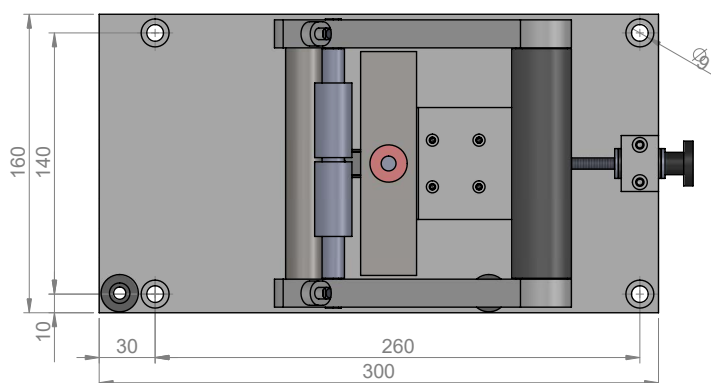
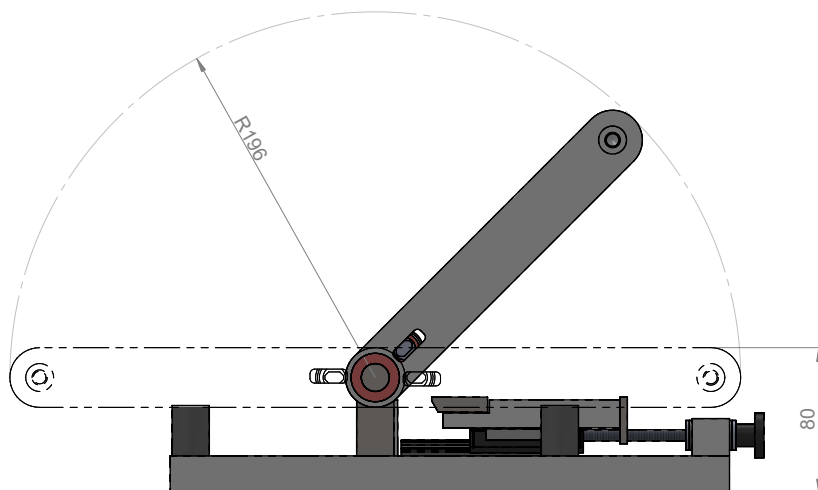
budatec

芯棒弯曲测试仪

焊接与烧结测试设备

DCB/芯片连接





技术数据

弯曲滚轮:	2 x Ø 20 mm x 40 mm (数量 × 直径 × 宽度)
重量:	5,5 kg
使用材料:	钢 铝 塑料

功能；特性

DCB固定用滑尺，可通过旋转旋钮调节；可沿轴向调节弯曲滚轮角度。
桌面使用安装孔